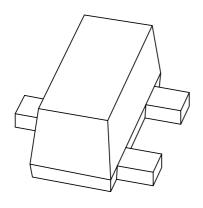
#### **DISCRETE SEMICONDUCTORS**

## DATA SHEET



# **2PC4617J**NPN general purpose transistor

Product specification Supersedes data of 1999 May 04 2001 Aug 03





### NPN general purpose transistor

#### 2PC4617J

#### **FEATURES**

- Power dissipation comparable to SOT23
- Low output capacitance
- Low saturation voltage V<sub>CEsat</sub>
- Low current (max. 100 mA)
- Low voltage (max. 50 V).

#### **APPLICATIONS**

• General purpose switching and amplification in miniaturized application areas such as telecom and multimedia.

#### **DESCRIPTION**

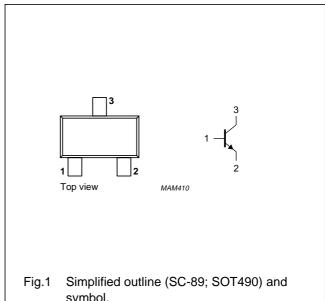
NPN transistor encapsulated in an ultra small plastic SMD SC-89 (SOT490) package. PNP complement: 2PA1774J.

#### **MARKING**

TYPE NUMBER	MARKING CODE
2PC4617QJ	ZQ
2PC4617RJ	ZR
2PC4617SJ	ZS

#### **PINNING**

PIN	DESCRIPTION
1	base
2	emitter
3	collector



symbol.

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	5	V
I <sub>C</sub>	collector current (DC)		_	100	mA
I <sub>CM</sub>	peak collector current		_	200	mA
I <sub>BM</sub>	peak base current		_	200	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

#### Note

1. Refer to SC-89 (SOT490) standard mounting conditions.

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#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	in free air; note 1	500	K/W

#### Note

1. Refer to SC-89 (SOT490) standard mounting conditions.

#### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	MIN.	MAX.	UNIT	
I <sub>CBO</sub>	collector cut-off current	I <sub>E</sub> = 0; V <sub>CB</sub> = 30 V	_	100	nA
		I <sub>E</sub> = 0; V <sub>CB</sub> = 30 V; T <sub>j</sub> = 150 °C	_	5	μΑ
I <sub>EBO</sub>	emitter cut-off current	I <sub>C</sub> = 0; V <sub>EB</sub> = 4 V	_	100	nA
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 1 mA; V <sub>CE</sub> = 6 V; note 1			
	2PC4617QJ		120	270	
	2PC4617RJ		180	390	
	2PC4617SJ		270	560	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = 50 \text{ mA}$ ; $I_B = 5 \text{ mA}$ ; note 1	_	200	mV
C <sub>c</sub>	collector capacitance	$I_E = i_e = 0$ ; $V_{CB} = 12 \text{ V}$ ; $f = 1 \text{ MHz}$	_	1.5	pF
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 2 mA; V <sub>CE</sub> = 12 V; f = 100 MHz; note 1	100	_	MHz

#### Note

1. Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

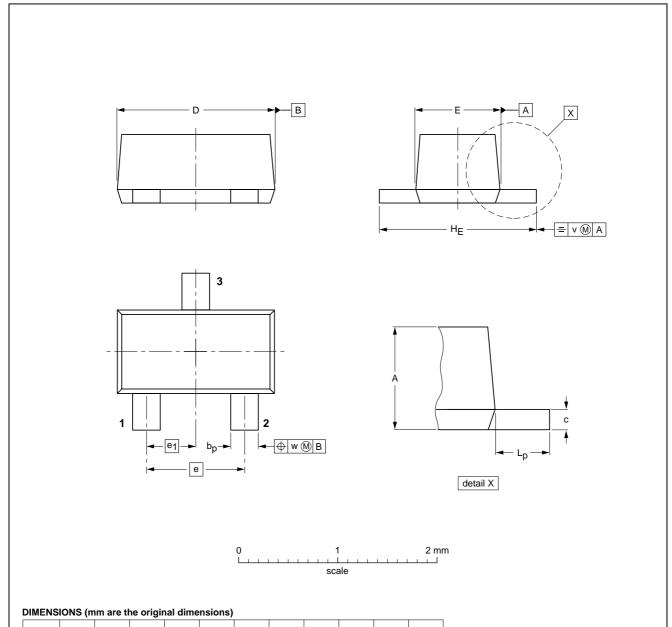
## NPN general purpose transistor

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#### **PACKAGE OUTLINE**

Plastic surface mounted package; 3 leads

SOT490



UNIT	Α	bp	С	D	E	е	e <sub>1</sub>	HE	L <sub>p</sub>	v
mm	0.8 0.6	0.33 0.23	0.2 0.1	1.7 1.5	0.95 0.75	1.0	0.5	1.7 1.5	0.5 0.3	0.1

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT490			SC-89		98-10-23

#### NPN general purpose transistor

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#### **DATA SHEET STATUS**

DATA SHEET STATUS(1)	PRODUCT STATUS <sup>(2)</sup>	DEFINITIONS
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## NPN general purpose transistor

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NOTES

## NPN general purpose transistor

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NOTES

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